

# DATA SHEET

**NEXEM**

RoHS2 Compliant

MINIATURE SIGNAL RELAY

## UA2/UB2 SERIES

**SUPER-COMPACT SIZE, SLIM-PACKAGE**

### DESCRIPTION

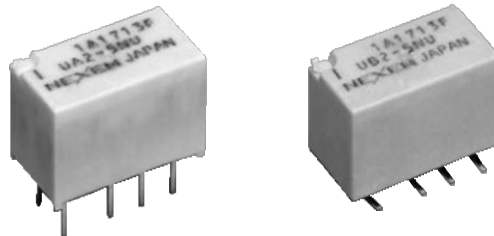
NEXEM UA2/UB2 relay is a new generation miniature signal relay, super-compact and slim.

### FEATURES

- Small mounting size of slim package for dense mounting
- Telcordia (2500 V) and FCC (1500 V) surge capacity
- IEC62368-1/ EN62368-1 spacing (Basic insulation class on 200 V working voltage)
- Low power consumption (100-230 mW)
- NZF type (high power switching) is UL recognized / CSA Certificated for 30Vdc, 2A (resistive load), supports maximum switching power of 60 W and maximum switching and carrying current of 2 A
- Moisture Barrier Bag (MBB) packaged UB2 relays meet moisture sensibility level (MSL) of IPC/JEDEC J-STD-020, ECA/IPC/JEDEC J-STD-075

### APPLICATIONS

Test Equipment, Electronic switching systems, PBX, Terminal equipment, Telephone system



#### For Right Use of Miniature Relays

##### **DO NOT EXCEED MAXIMUM RATINGS.**

Do not use relays under exceeding conditions such as over ambient temperature, over voltage and over current. Incorrect use could result in abnormal heating, damage to related parts or cause burning.

##### **READ CAUTIONS IN THE SELECTION GUIDE.**

Read the cautions described in EM Devices' "Miniature Relays" when you choose relays for your application.

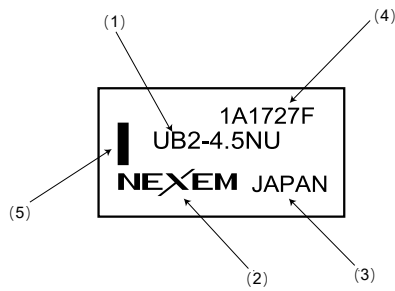
The information in this document is subject to change without notice.

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**MARKINGS (Top view)**



- (1) Part number
- (2) Manufacturer
- (3) Country of origin
- (4) Date code
- (5) Direction mark (pin No. 1 and 8)

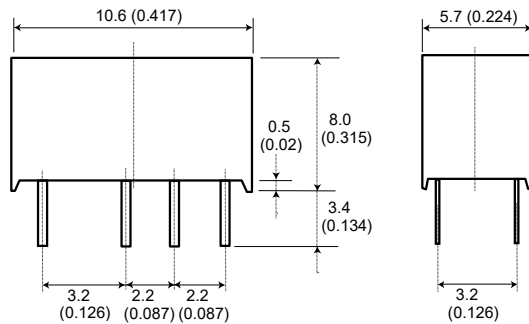
**DIMENSIONS**

● **UA2 SERIES**

Unit: mm (inch)

**DIMENSIONS**

**STANDARD / TRIMMED LEAD TYPE**

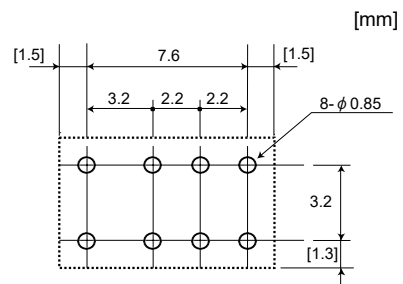


Tolerance of lead pitch is  $\pm 0.15\text{mm}$  (0.006inch)  
Other tolerances  $\pm 0.3\text{mm}$  (0.012inch)

Lead size  $0.4 \times 0.2 \pm 0.1$

Trimmed lead type: Lead length 2.8mm

**PAD LAYOUTS (Bottom view)**

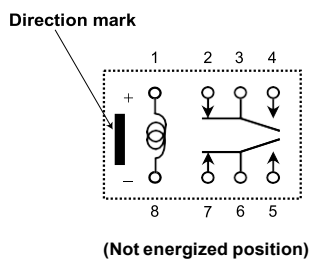


NOTE. General tolerance:  $\pm 0.1$

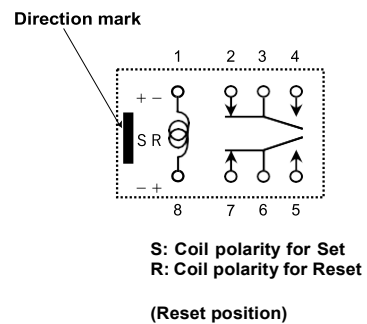
(Bottom view)

**PIN CONFIGURATIONS (Bottom view)**

**Non-latch type**



**Single coil latch type**



S: Coil polarity for Set  
R: Coil polarity for Reset

(Reset position)



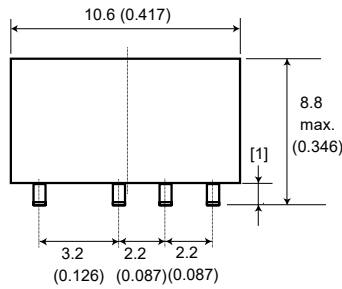
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● **UB2 SERIES**

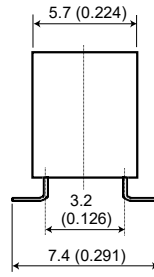
**Unit: mm (inch)**

**DIMENSIONS**

**STANDARD**

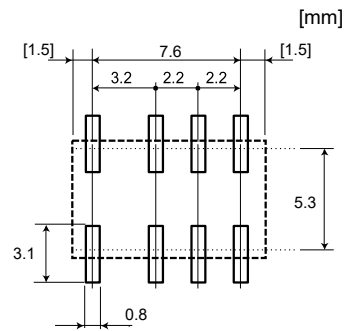


Tolerance of lead pitch is  $\pm 0.15\text{mm}$  (0.006inch)  
 Other tolerances  $\pm 0.3\text{mm}$  (0.012inch)  
 Coplanarity of terminals is 0.1mm max.



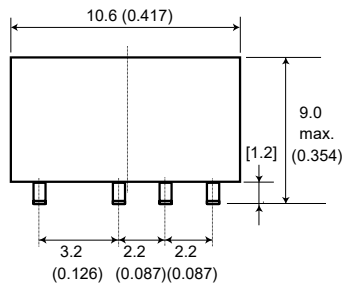
Lead size  $0.4 \times 0.2 \pm 0.1$

**PAD LAYOUTS (Top view)**

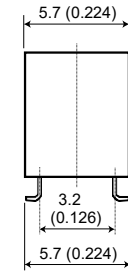


NOTE. General tolerance:  $\pm 0.1$

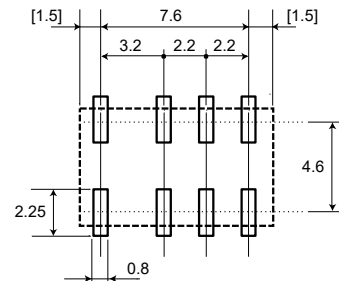
**MINIMUM FOOTPRINT TYPE**



Tolerance of lead pitch is  $\pm 0.15\text{mm}$  (0.006inch)  
 Other tolerances  $\pm 0.3\text{mm}$  (0.012inch)  
 Coplanarity of terminals is 0.1mm max.



Lead size  $0.4 \times 0.2 \pm 0.1$

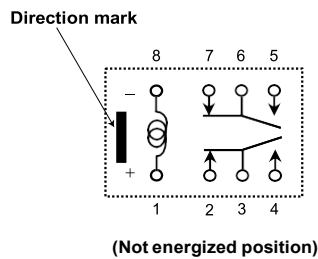


NOTE. General tolerance:  $\pm 0.1$

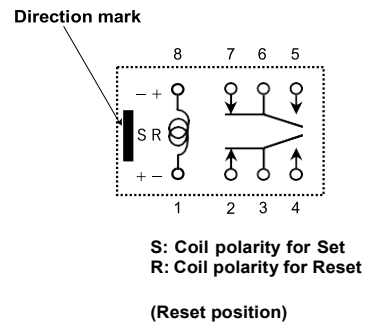
(Top view)

**PIN CONFIGURATIONS (Top view)**

**Non-latch type**



**Single coil latch type**



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**GENERAL SPECIFICATIONS**

Contact Form		2 Form C
Contact Material	Standard	Silver alloy with gold alloy overlay
	High power switching type	Silver with gold alloy overlay
Maximum Switching Power	Standard	30 W, 37.5 VA (resistive)
	High power switching type	60 W, 37.5 VA (resistive)
Maximum Switching Voltage		220 Vdc, 250 Vac
Maximum Switching Current	Standard	1 A
	High power switching type	2 A
Maximum Carrying Current	Standard	1 A
	High power switching type	2 A
Minimum Contact Ratings		10 m Vdc, 10µA *1
Initial Contact Resistance		100 m Ω max.
Operate Time [Set Time] (Excluding bounce)		Approx. 2 ms [2ms]
Release Time [Reset Time] (Excluding bounce)		Approx. 1 ms [2ms] (Without diode)
Insulation Resistance		1000 MΩ at 500 Vdc
Withstanding Voltage	Between open contacts	1000 Vac (for one minute), 1500 V surge (10x160 µs *2)
	Between adjacent contacts	1000 Vac (for one minute), 1500 V surge (10x160 µs *2)
	Between coil and contacts	1800 Vac (for one minute), 2500 V surge (2x10 µs *3)
Shock Resistance		735 m/s <sup>2</sup> (75G) (misoperation) 980 m/s <sup>2</sup> (100G) (destructive failure)
Vibration Resistance		10 to 55 Hz, double amplitude 3 mm (196 m/s <sup>2</sup> ) (misoperation) 10 to 55 Hz, double amplitude 5 mm (294 m/s <sup>2</sup> ) (destructive failure)
Ambient Temperature		-40 to +85 °C
Coil Temperature Rise		13 °C / 100mW, 18 °C / 140mW, 28 °C / 230mW at nominal coil Voltage
Running Specifications	Non-load	5x10 <sup>7</sup> operations (Non-latch type) *4 1x10 <sup>7</sup> operations (latch type)
	Load	30 Vdc 1A (resistive), 1x10 <sup>5</sup> operations at 20 °C, 1 Hz
		125 Vac 0.3 A (resistive), 1x10 <sup>5</sup> operations at 20 °C, 1 Hz
	(Only High power switching type)	30 Vdc 2 A (resistive), 5x10 <sup>4</sup> operations at 20 °C, 1 Hz
Weight		Approx. 1 g

\* 1 This value is a reference value in the resistive load.

Minimum capacity changes depending on switching frequency and environment temperature and the load.

\* 2 rise time: 10 µs, decay time to half crest: 160 µs

\* 3 rise time: 2 µs, decay time to half crest: 10 µs

\* 4 This shows the number of operations without fatal defects. Stable characteristics are maintained for 1 × 10<sup>7</sup> operations.



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**COIL SPECIFICATIONS**

**Non-latch Type** at 20 °C

Nominal Coil Voltage (Vdc)	Coil Resistance (Ω)±10%	Must Operate Voltage* (Vdc)	Must Release Voltage* (Vdc)	Nominal Operating Power (mW)
3	64.3	2.25	0.3	140
4.5	145	3.38	0.45	140
5	178	3.75	0.5	140
9	579	6.75	0.9	140
12	1028	9.0	1.2	140
24	2504	18.0	2.4	230

**Single Coil Latch Type** at 20 °C

Nominal Coil Voltage (Vdc)	Coil Resistance (Ω)±10%	Must Set Voltage* (Vdc)	Must Reset Voltage* (Vdc)	Nominal Operating Power (mW)
3	90	2.25	2.25	100
4.5	202.5	3.38	3.38	100
5	250	3.75	3.75	100
9	810	6.75	6.75	100
12	1440	9.0	9.0	100

Note: Apply the coil voltage so that the No.1 pin is on the + side when set and the No.8 pin is on the + side when reset.

**Non-latch Low Power Consumption Type** at 20 °C

Nominal Coil Voltage (Vdc)	Coil Resistance (Ω)±10%	Must Operate Voltage* (Vdc)	Must Release Voltage* (Vdc)	Nominal Operating Power (mW)
3	90	2.25	0.3	100
4.5	202.5	3.38	0.45	100
5	250	3.75	0.5	100

Note: \* Test by pulse voltage

**SAFETY STANDARD AND RATING**

UL Recognized (UL508) * File No E73266		CSA Certified (CSA C22.2 No14) ** File No LR46266	
Standard		High power switching type	
30 Vdc, 1 A (Resistive)		30 Vdc, 2 A (Resistive)	
110 Vdc, 0.3 A (Resistive)		110 Vdc, 0.3 A (Resistive)	
125 Vac, 0.3 A (Resistive)		125 Vac, 0.3 A (Resistive)	

\* Spacing: UL840, \*\*Spacing: CSA std950

TUV Certificate (EN61810-1)
No. R2050596 ***
Creepage and clearance of coil to contact is more than 2 mm. (According to EN62368-1)
Basic insulation class

\*\*\*High power switching type are not supported TUV certified.

**RECOMMENDED RELAY DRIVE CONDITIONS**

Drive under conditions.

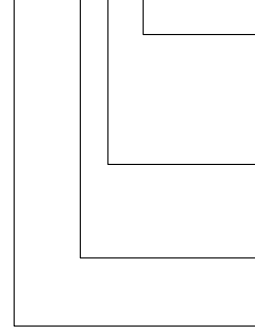
Non-latch type	Voltage: within ±5% of nominal voltage	Ambient temperature - 40 to +85 °C
Single coil latch type	Square pulse (rise and fall time is rapid) pulse height: within ±5% of nominal voltage pulse width: more than 10 ms	



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**PART NUMBER SYSTEM**

UA2 - 3 S NU



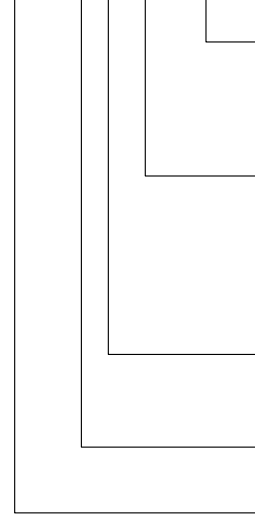
Option  
 NU: Standard  
 NJ: Trimmed lead type  
 NE: Low power consumption type  
 NZF: High power switching type

Latch type  
 Nil: Non-latch type  
 S: Single coil latch type

Nominal coil voltage  
 (A numerical value of coil voltage)

UA2 series

UB2 - 3 S NU - L



Packing  
 Nil: Tube  
 L: Embossed carrying tape  
 L8: Embossed carrying tape with Moisture Barrier Bag (MBB)  
 (To meet for 250 °C reflow condition: MSL 4)

Option  
 NU: Standard  
 NUN: Minimum footprint type  
 NE: Low power consumption type  
 NEN: Low power consumption, Minimum footprint type  
 NZF: High power switching type  
 NZFN: High power switching, Minimum footprint type

Latch type  
 Nil: Non-latch type  
 S: Single coil latch type

Nominal coil voltage  
 (A numerical value of coil voltage)

UB2 series

**ORDERING PART NUMBERS**

□ UA2 series

Option		Nominal Coil Voltage (Vdc)	Coil Type		
Terminal	Packing		Non-latch	Single Coil Latch	Non-latch Low power consumption
Standard	Tube	3	UA2-3NU	UA2-3SNU	UA2-3NE
		4.5	UA2-4.5NU	UA2-4.5SNU	UA2-4.5NE
		5	UA2-5NU	UA2-5SNU	UA2-5NE
		9	UA2-9NU	UA2-9SNU	-
		12	UA2-12NU	UA2-12SNU	-
		24	UA2-24NU	-	-
Trimmed lead	Tube	3	UA2-3NJ	UA2-3SNJ	-
		4.5	UA2-4.5NJ	UA2-4.5SNJ	-
		5	UA2-5NJ	UA2-5SNJ	-
		9	UA2-9NJ	UA2-9SNJ	-
		12	UA2-12NJ	UA2-12SNJ	-
		24	UA2-24NJ	-	-



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□ UB2 series

Option		Nominal Coil Voltage (Vdc)	Coil Type		
Terminal	Packing		Non-latch	Single Coil Latch	Non-latch Low power consumption
Standard	Tube	3	UB2-3NU	UB2-3SNU	UB2-3NE
		4.5	UB2-4.5NU	UB2-4.5SNU	UB2-4.5NE
		5	UB2-5NU	UB2-5SNU	UB2-5NE
		9	UB2-9NU	UB2-9SNU	-
		12	UB2-12NU	UB2-12SNU	-
		24	UB2-24NU	-	-
	Taping	3	UB2-3NU-L	UB2-3SNU-L	UB2-3NE-L
		4.5	UB2-4.5NU-L	UB2-4.5SNU-L	UB2-4.5NE-L
		5	UB2-5NU-L	UB2-5SNU-L	UB2-5NE-L
		9	UB2-9NU-L	UB2-9SNU-L	-
		12	UB2-12NU-L	UB2-12SNU-L	-
		24	UB2-24NU-L	-	-
	Taping (MBB)	3	UB2-3NU-L8	UB2-3SNU-L8	UB2-3NE-L8
		4.5	UB2-4.5NU-L8	UB2-4.5SNU-L8	UB2-4.5NE-L8
		5	UB2-5NU-L8	UB2-5SNU-L8	UB2-5NE-L8
		9	UB2-9NU-L8	UB2-9SNU-L8	-
		12	UB2-12NU-L8	UB2-12SNU-L8	-
		24	UB2-24NU-L8	-	-
Minimum footprint	Tube	3	UB2-3NUN	UB2-3SNUN	UB2-3NEN
		4.5	UB2-4.5NUN	UB2-4.5SNUN	UB2-4.5NEN
		5	UB2-5NUN	UB2-5SNUN	UB2-5NEN
		9	UB2-9NUN	UB2-9SNUN	-
		12	UB2-12NUN	UB2-12SNUN	-
		24	UB2-24NUN	-	-
	Taping	3	UB2-3NUN-L	UB2-3SNUN-L	UB2-3NEN-L
		4.5	UB2-4.5NUN-L	UB2-4.5SNUN-L	UB2-4.5NEN-L
		5	UB2-5NUN-L	UB2-5SNUN-L	UB2-5NEN-L
		9	UB2-9NUN-L	UB2-9SNUN-L	-
		12	UB2-12NUN-L	UB2-12SNUN-L	-
		24	UB2-24NUN-L	-	-
	Taping (MBB)	3	UB2-3NUN-L8	UB2-3SNUN-L8	UB2-3NEN-L8
		4.5	UB2-4.5NUN-L8	UB2-4.5SNUN-L8	UB2-4.5NEN-L8
		5	UB2-5NUN-L8	UB2-5SNUN-L8	UB2-5NEN-L8
		9	UB2-9NUN-L8	UB2-9SNUN-L8	-
		12	UB2-12NUN-L8	UB2-12SNUN-L8	-
		24	UB2-24NUN-L8	-	-

Note:

1. Only MBB packaging part numbers meet MSL (L8: MSL 4). However, it does not fully conform to IPC/JEDEC standards. Please note that part numbers other without MBB packaging do not meet MSL.



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□ UA2 series / High power switching type

Option		Nominal Coil Voltage (Vdc)	Coil Type	
Terminal	Packing		Non-latch	Single Coil Latch
Standard	Tube	3	UA2-3NZF	UA2-3SNZF
		4.5	UA2-4.5NZF	UA2-4.5SNZF
		5	UA2-5NZF	UA2-5SNZF
		9	UA2-9NZF	UA2-9SNZF
		12	UA2-12NZF	UA2-12SNZF
		24	UA2-24NZF	-

□ UB2 series / High power switching type

Option		Nominal Coil Voltage (Vdc)	Coil Type	
Terminal	Packing		Non-latch	Single Coil Latch
Standard	Taping (MBB)	3	UB2-3NZF-L8	UB2-3SNZF-L8
		4.5	UB2-4.5NZF-L8	UB2-4.5SNZF-L8
		5	UB2-5NZF-L8	UB2-5SNZF-L8
		9	UB2-9NZF-L8	UB2-9SNZF-L8
		12	UB2-12NZF-L8	UB2-12SNZF-L8
		24	UB2-24NZF-L8	-
Minimum footprint	Taping (MBB)	3	UB2-3NZFN-L8	UB2-3SNZFN-L8
		4.5	UB2-4.5NZFN-L8	UB2-4.5SNZFN-L8
		5	UB2-5NZFN-L8	UB2-5SNZFN-L8
		9	UB2-9NZFN-L8	UB2-9SNZFN-L8
		12	UB2-12NZFN-L8	UB2-12SNZFN-L8
		24	UB2-24NZFN-L8	-

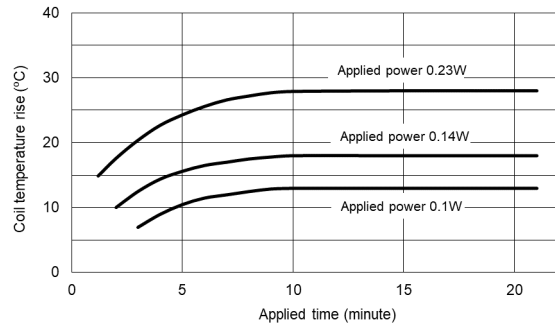
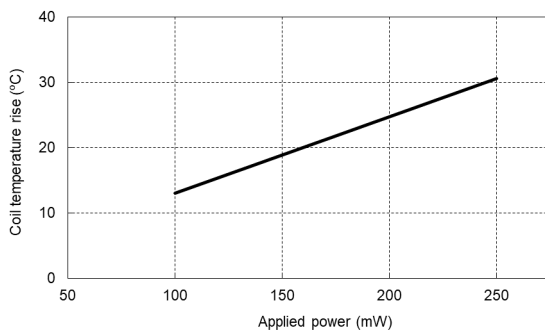
Note:

- The packaging specification for UB2 relay high power switching type is only Taping with MBB (MSL 4). Please note that other packaging specifications are not supported.

**PERFORMANCE DATA**

□ COIL TEMPERATURE RISE

Temperature is measured by coil resistance.

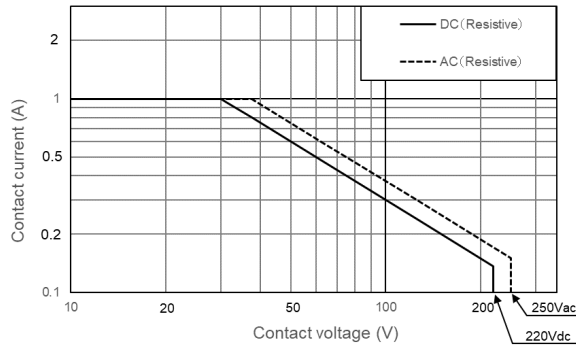


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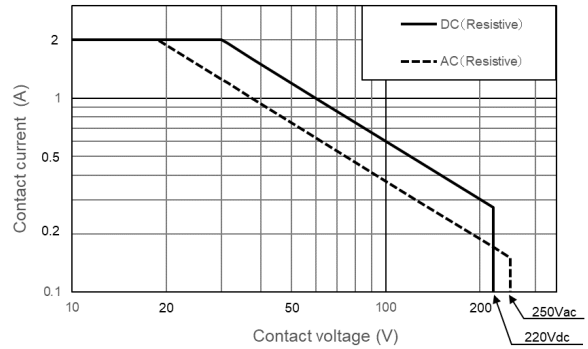
□ SWITCHING CAPACITY

This is allowed maximum value.

Inquire with EM Devices for maximum value under continuous



(Standard)

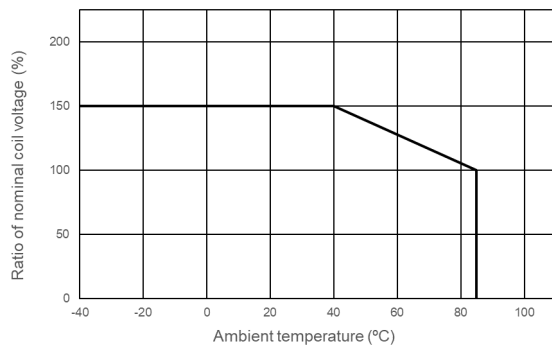


(High power switching type)

□ MAXIMUM COIL VOLTAGE

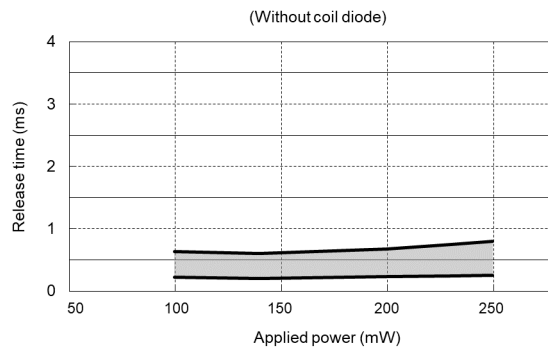
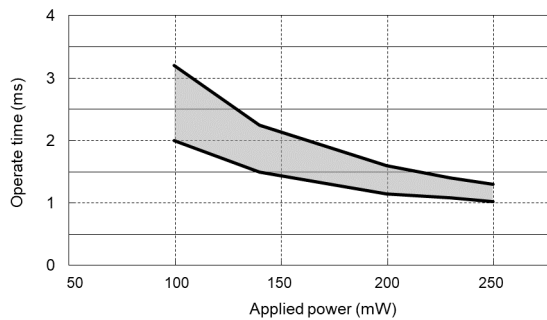
This is a maximum value of permissible alteration.

Inquire with EM Devices under continuous use.



□ APPLIED POWER VS. TIMING

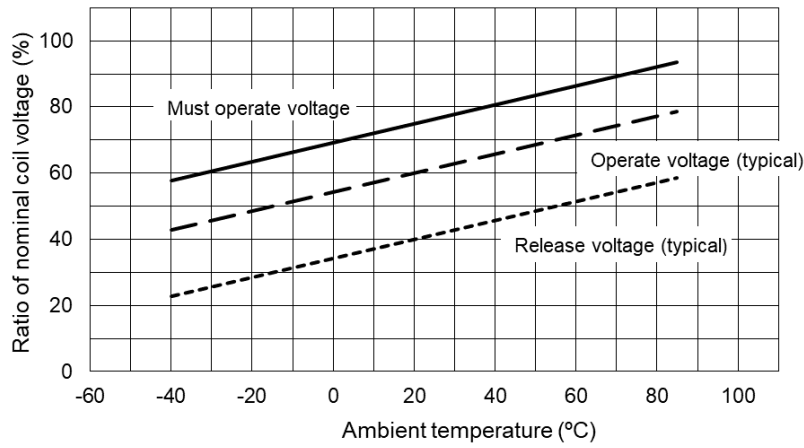
(Sample: UA2-5NU)



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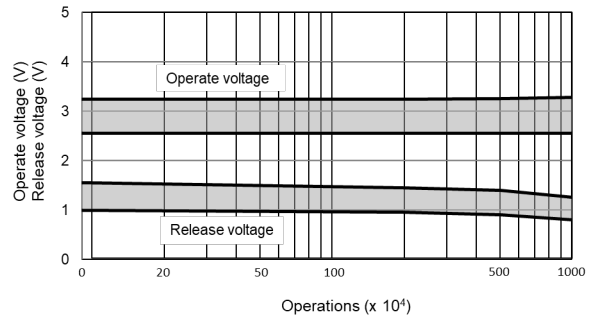
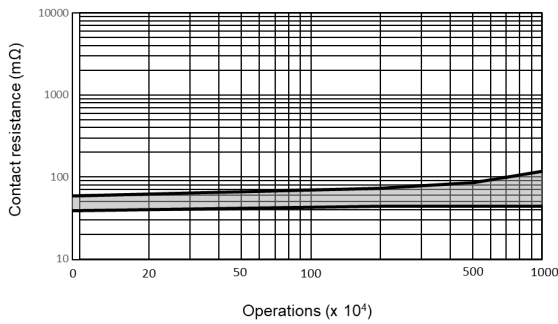
□ OPERATE AND RELEASE VOLTAGE VS. AMBIENT TEMPERATURE

This shows a typical change of operate (release) voltage. The value of must operate is estimated, so coil voltage must be applied more than this value for safety operation. For hot start operation, please inquire with EM Devices.



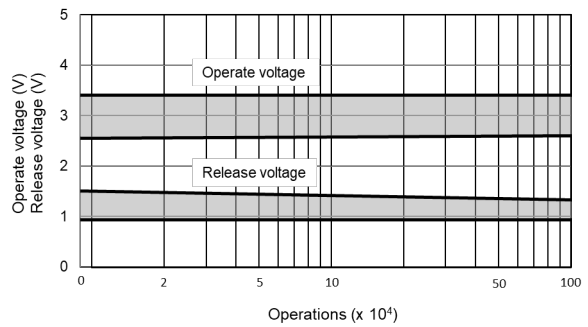
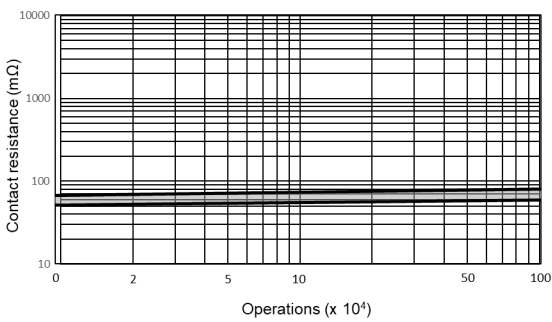
□ RUNNING TEST (Non-load)

(Load: none, Drive: 5Vdc, 50Hz, 50%duty, Ambient temperature: room temperature, Sample: UA2-5NU, 20pieces)



□ RUNNING TEST (Load)

(Load: 50Vdc 0.1A resistive, Drive: 5Vdc, 5Hz, 50%duty, Ambient temperature:85°C, Sample: UA2-5NU, 10pieces)

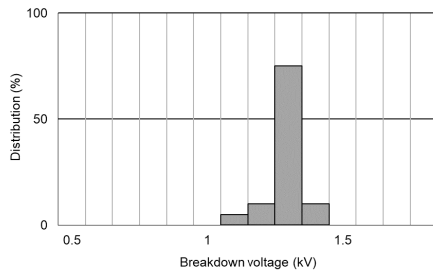


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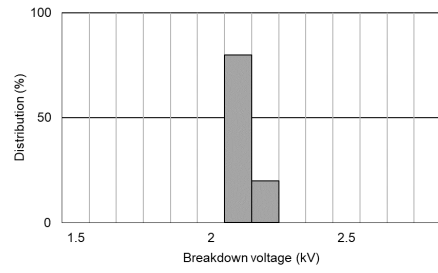
□ BREAKDOWN VOLTAGE

Sample: UA2-5NU 10pieces

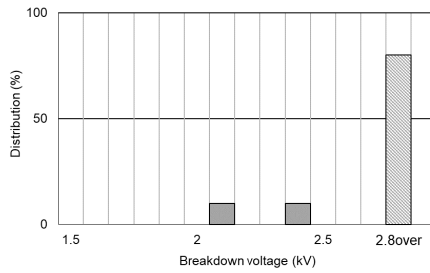
(a) Between open contacts



(b) Between adjacent contacts



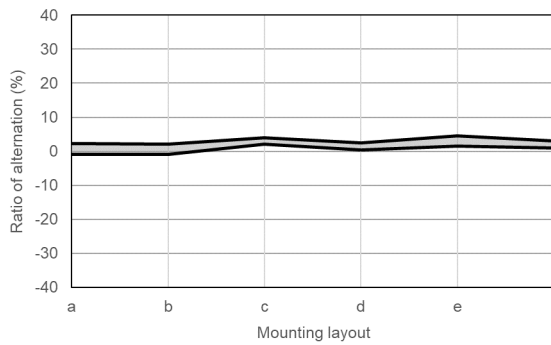
(c) Between coil and contacts



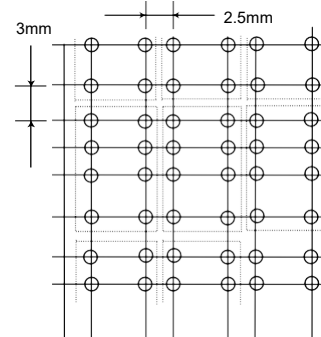
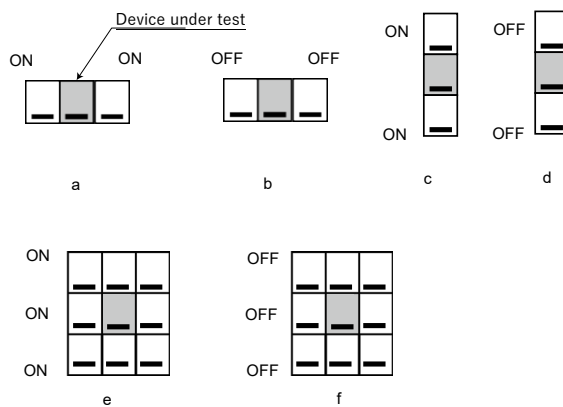
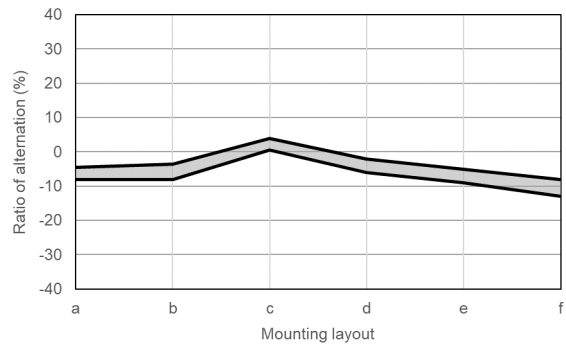
Note: Applying 2.8 kVac or more may cause of breakdown outside U series relay (between terminals).

□ ALTERNATION OF VOLTAGE AT DENSELY MOUNTING (Magnet interference)

Alternation of operate voltage



Alternation of release voltage

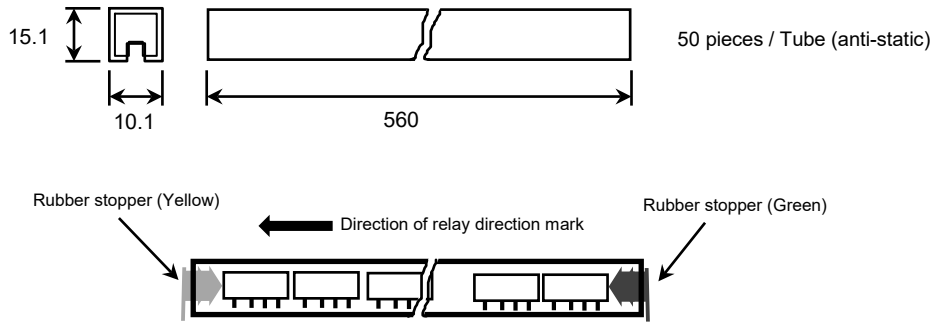


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**PACKING DIMENSIONS**

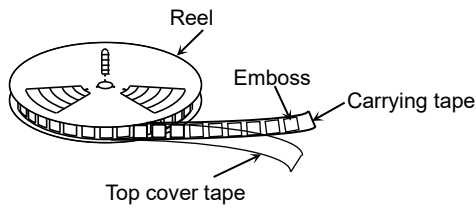
**(Unit: mm)**

**TUBE PACKING (UA2/UB2)**



**TAPE PACKING (UB2)**

**APPEARANCE**

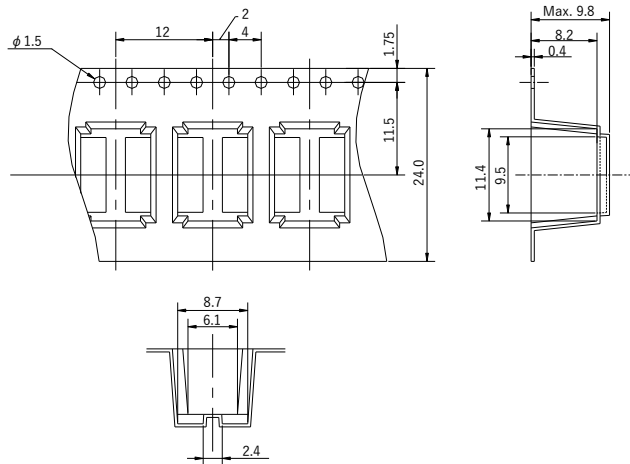


Reel material: Corrugated Cardboard (L)  
PS (L8 : MBB)

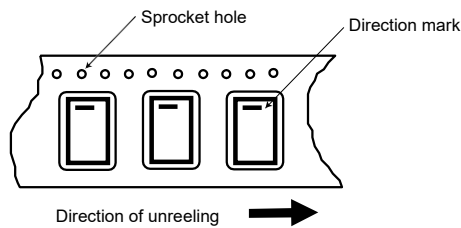
Relay quantity: 800 pieces / Reel (L)  
750 pieces / Reel (L8 : MBB)  
\*Two reels are sealed in one MBB.

Reel diameter: 380mm

**TAPE DIMENSIONS**



**RELAY DIRECTION AND TAPE CARRYING DIRECTION**



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**SOLDERING TEMPERATURE CONDITION**

**THROUGH-HOLE MOUNTING (UA2)**

1. Automatic soldering

Preheating (Terminal): 110~ 120°C / 110s. max.  
 Solder temperature: 260°C max.  
 Soldering time: 5s max.

Note: EM Devices recommends cooling down a printed circuit board less than 110°C within 40s after soldering.  
 The above are flow soldering conditions. Check the actual soldering condition to use other automatic soldering methods.

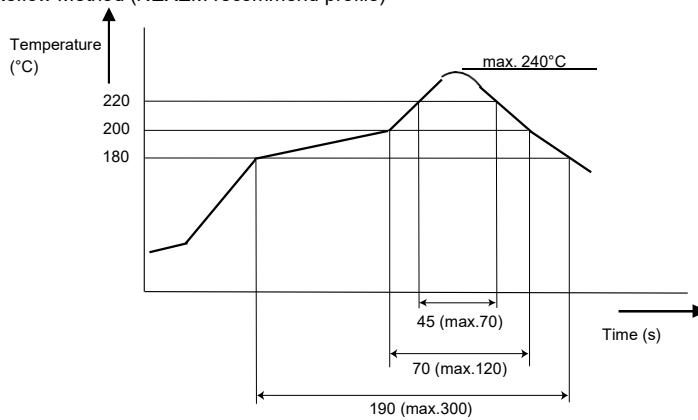
2. Manual soldering (by soldering iron)

Soldering temperature (Tip): 350°C max.  
 Soldering time: 3 s max.

Note: Heating of this product by automatic soldering and manual soldering is limited to a total of three times.

**SURFACE-MOUNTING TYPE (UB2)**

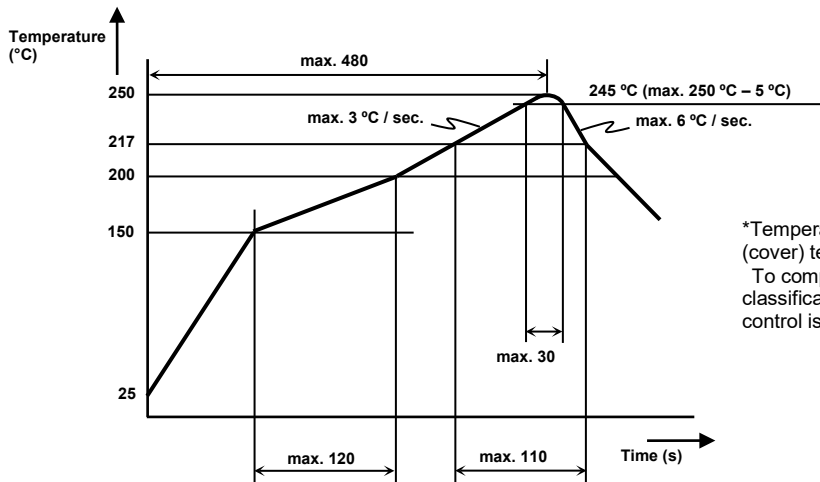
1. Reflow Method (NEXEM recommend profile)



\*Temperature profile shows printed circuit board surface temperature on the relay terminal portion.

2. Reflow Method (JEDEC compliant profile)

\*Product name only to meet for 250 °C reflow condition (L8 packaging)



\*Temperature profile shows body (cover) temperature.  
 To comply with this 250°C classification temperature, MSL 4 control is absolutely necessary.

Note:

1. Heating by reflow should be limited to two times. However, allow sufficient time for cooling of the product between the first and second reflow.
2. Check the actual soldering condition to use other method except above mentioned temperature profiles.



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NOTE ON CORRECT USE

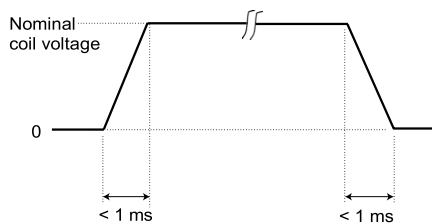
1. Notes on contact load

Make sure that the contact load is within the specified range; otherwise, the lifetime of the contacts will be shortened considerably.

Note that the running performance shown is an example, and that it varies depending on parameters such as the type of load, switching frequency, driver circuit, and ambient temperature under the actual operating conditions. Evaluate the performance by using the actual circuit before using the relay.

2. Driving relays

- If the internal connection diagram of a relay shows + and - symbols on the coil, apply the rated voltage to the relay in the specified direction. If a rippled DC current source is used, abnormalities such as beat at the coil may occur.
- The maximum voltage that can be applied to the coil of the relay varies depending on the ambient temperature. Generally, the higher the voltage applied to the coil, the shorter the operating time. Note, however, that a high voltage also increases the bounce of the contacts and the contact opening and closing frequency, which may shorten the lifetime of the contacts.
- If the driving voltage waveform of the relay coil rises and falls gradually, the inherent performance of the relay may not be fully realized. Make sure that the voltage waveform instantaneously rises and falls as a pulse.

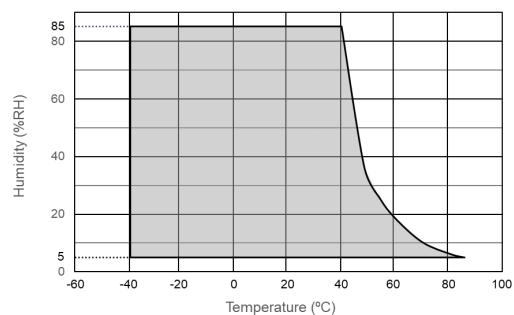


- For a latching relay, apply a voltage to the coil according to the polarity specified in the internal connection diagram of the relay.
- If a current is applied to the coil over a long period of time, the coil temperature rises, promoting generation of organic gas inside the relay, which may result in faulty contacts. In this case, use of a latching relay is recommended.
- The operating time and release time indicate the time required for each contact to close after the voltage has been applied to or removed from the coil. However, because the relay has a mechanical structure, a bounce state exists at the end of the operating and release times. Furthermore, because additional time is required until the contact stabilizes after being in a high-resistance state, care must be taken when using the relay at high speeds.

3. Operating environment

- Make sure that the relay mounted in the application set is used within the specified temperature range. Use of a relay at a temperature outside this range may adversely affect insulation or contact performance.

- If the relay is used for a long period of time in highly humid (RH 85% or higher) environment, moisture may be absorbed into the relay. This moisture may react with the NOx and SOx generated by glow discharges that occur when the contacts are opened or closed, producing nitric or sulfuric acid. If this happens, the acid produced may corrode the metallic parts of the relay, causing operational malfunction.
- If any material containing silicone (silicone rubber, silicone oil, and silicone-based coating material) is used in the neighborhood of relay, there is some possibility that these materials will emit silicone gas that will penetrate the relay. In this case, the switching contact may generate silicone on the surface of contacts. This silicone may result in contact failure. Avoid use of relay in such an environment.
- Because the operating temperature range varies depending on the humidity, use the relay in the temperature range illustrated in the figure below. Prevent the relay from being frozen and avoid the generation of condensation.



- The same applies when the relay is stored or transported. Keep the upper-limit value of the temperature to which the relay is exposed after it is removed from the carton box to within 50°C. Please also refer to "5. Handling" for SMT relays.
- Permanent magnets are used in polarized relays. For this reason, when magnets, transformers, or speakers are located nearby the relay characteristics may change and faulty operations may result.
- The relay maintains constant sealability under normal atmospheric pressure (810 to 1,200 hPa). Its sealability may be degraded or the relay may be deformed and malfunction if it is used under barometric conditions exceeding the specified range. Avoid using vacuum oven during baking or drying cleaning solutions.
- If excessive vibration or shock is applied to the relay, it may malfunction, and the contacts remain closed. Vibration or shock applied to the relay during operation may cause considerable damage to or wearing of the contacts. Note that operation of a snap switch mounted close to the relay or shock due to the operation of magnetic solenoid may also cause malfunctioning.



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4. Notes on mounting relays

- When mounting a relay onto a PC board using an automatic chip mounter, if excessive force is applied to the cover of the relay when the relay is chucked or inserted, the cover may be damaged, or the characteristics of the relay degraded. Keep the force applied to the relay to within 1 kg.
- Avoid bending the pins to temporarily secure the relay to the PC board. Bending the pins may degrade sealability or adversely affect the internal mechanism.
- It is recommended to solder the relay onto a PC board under the following conditions:

<1> Reflow soldering

Refer to the recommended soldering temperature profile. Please note that excessive heating beyond the specified peak temperature or heating time will damage the airtightness.

<2> Flow soldering

Solder temperature: 260°C max., Time: 5s max.

Preheating (Terminals): 110~120°C / 110s. (max.)

EM Devices recommends cooling down a printed circuit board less than 110°C within 40 seconds after soldering.

<3> Manual soldering

Soldering temperature (Tip): 350°C, Time: 3s max.

Avoid immersing the relay in cleaning solvent immediately after soldering due to the danger of thermal shock being applied to the relay.

- Use an alcohol-based or water-based cleaning solvent. Never use thinner and benzene because they may damage the relay housing.
- Do not use ultrasonic cleaning because the vibration energy generated by the ultrasonic waves may cause the contacts to remain closed.
- When using a vacuum oven to dry the cleaning solution, the relay's seal-ability may be compromised. Avoid drying conditions lower than normal atmospheric pressure.

5. Handling

- Relays are packaged in magazine cases for shipment. If a space is created in the case after some relays have been removed, be sure to insert a stopper to secure the remaining relays in the case. If relays are not well secured, vibration during transportation may cause malfunctioning of the contacts.
- Exercise care in handling the relay so as to avoid dropping it or allowing it to fall. Do not use a relay that has been dropped. If a relay drops from a workbench to the floor, a shock of 9,800 m/s<sup>2</sup> (1,000 G) or more is applied to the relay, possibly damaging its functions. Even if a light shock has been applied to the relay, thoroughly evaluate its operation before using it.
- Latching relays are factory-set to the reset state for shipment. A latching relay may be set, however, by vibration or shock applied while being transported. Be sure to forcibly reset the relay before using it in the application set. Also note that the relay may be set by unexpected vibration or shock when it is used in a portable set.

- The sealability of a surface mount type (SMT) relay may be lost if the relay absorbs moisture and is then heated during soldering. When storing relays, therefore, observe the following points:

<1> For standard packing

(a). Pack state

Term: Less than 12 months after our shipment.  
(Recommend using the product within 3 months if possible.)

Conditions: <30 °C, <60% RH

(b). Require bake before mounting, when relays not used within the above (a) period or was stored outside above (a) conditions.

Simple relay: Please dehumidify 85 ± 5 °C, 48 hours or more after transferring to a heat-resistant container.

Tape packing: Please dehumidify 50 ± 5 °C, 300 hours or more in reel condition.

Tube packaging should be baking on simple relays, removed from tube.

Relays after baking should be mounted within 3 months under the conditions in (a).

Standard packaging specification products do not meet with the JEDEC standard's Moisture Sensitivity Level (MSL) because they are not MBB packaged. If MSL compliance is required, use MBB packaging specification products.

<2> For MBB packing

(a). MBB state

Term: Less than 12 months after our shipment

Conditions: <30 °C, <60% RH

(b). After opening of MBB

Term: Within the time limit indicated on the caution label attached to MBB.

Conditions: <30 °C, <60% RH

(c). Require bake before mounting, when relays not used within the above (a) or (b) period or was stored outside above conditions.

Simple relay: Please dehumidify 85 ± 5 °C, 48 hours or more after transferring to a heat-resistant container.

Tape packing: Please dehumidify 50 ± 5 °C, 300 hours or more in reel condition. Please keep in mind that barrier pack needs to remove in that case.

Relays after baking should be mounted within the time limits according to MSL on the caution label under the conditions in (b).

The humidity indicator card included in MBB package immediately after opening should also be used as a basis for judging baking procedures.



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(Note)

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